



The TPA32xx family: The new Benchmark in Integrated Power Amplifiers

TPA3244 / TPA3245 / TPA3250 / TPA3251 / TPA3255

What we design?





Design for High-Resolution Audio

Designed for 96kHz / 24bit and 192kHz / 24bit high definition audio systems



Lowest output noise and lowest THD from any Class-D

Optimized Energy Performance

Optimized to be efficient no matter the active output power, Highest power output to idle-loss ratio ever

Smallest Solution Size

Integrated modulator, FETs, and <u>protection</u> reduce the size and cost of the solution

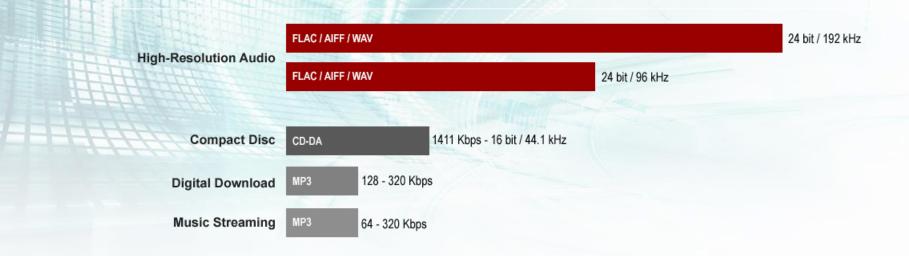




Audio Format Trends



Audio download and streaming services are moving towards Hi-Res audio formats like FLAC



The **TPA32xx** enables **true premium high definition audio sound quality** (HD Audio / High Resolution Audio) with the **support of up to 192kHz / 24bit**

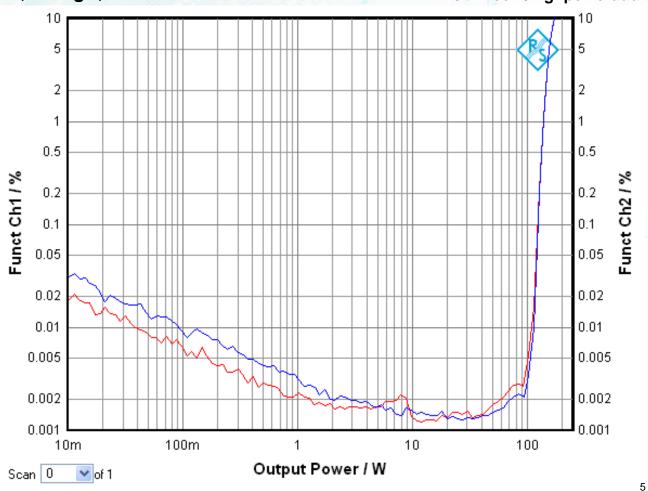
Highest Bandwidth Ever

Your Source for Inspiration
Visit Tl.com/highpoweraudio

TPA32xx – THD+N vs Power – 4Ω, 1kHz, Diff Input, 25degC, 250kHz BW

- Best THD+N all the way to clipping
- Increased loop bandwidth to minimize audio distortion

Graph shows THD+N performance using a 250kHz bandwidth meter (not A-weighted)



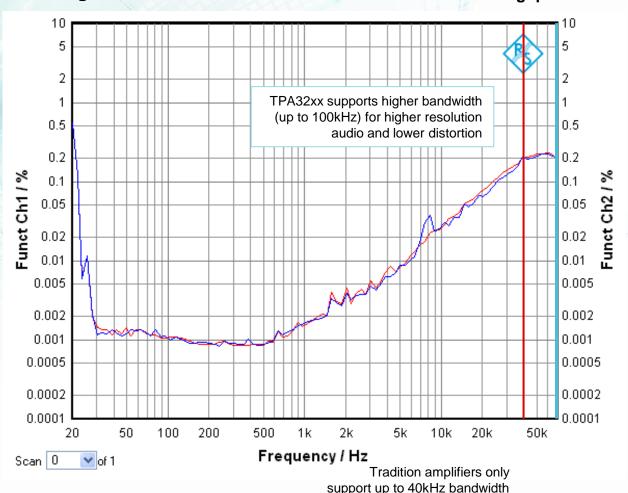
Highest Bandwidth Ever

TPA32xx – THD+N vs Frequency – 4Ω, 10W, Diff Input, 25degC, 250kHz BW



- Traditional amplifiers only support up to 40kHz bandwidth
- TPA32xx increased loop bandwidth up to 100kHz supports highresolution audio

Graph shows THD+N performance using a 250kHz bandwidth meter (not A-weighted)



Unrivaled Audio Performance & Power



TPA32xx – THD+N vs Output Power - BTL Single Channel



✓ Innovative closed-loop

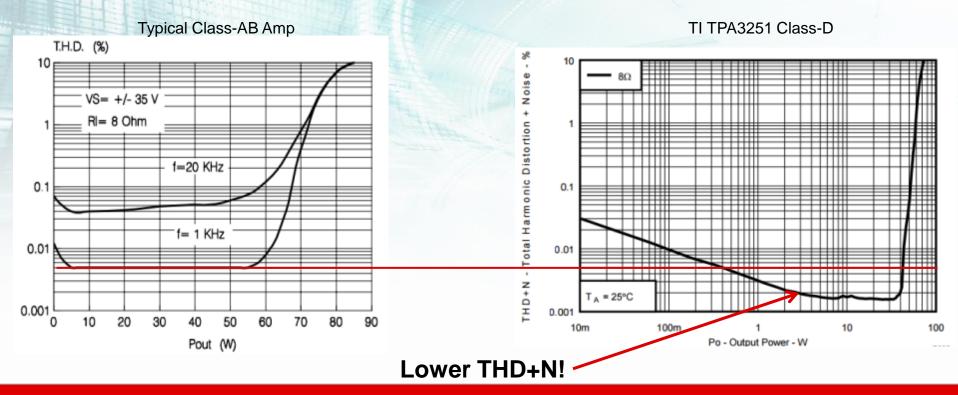
THD as low as .005%

With noise < 60uV, < half of the output noise of the nearest

TPA32xx Class-D vs Class-AB Performance



Due to the extremely high audio performance of the TPA32xx amplifier family, Class-D can now compete and replace Class-AB amplifier performance!



When is it important to be efficient?



TPA32xx is >90% efficiency at full power for high power applications; however, audio does
not always operate at peak output power...



 With most audio having a crest factor of 1/8, low power and idle operation are very important.

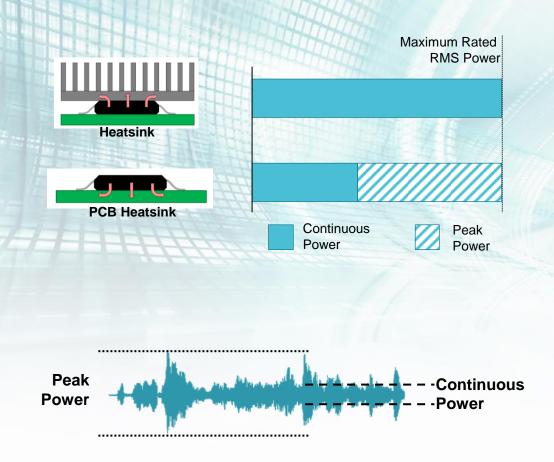
Music Crest Factor =
$$\frac{Peak\ power}{Continuous\ Power} = \frac{1}{8}$$

TPA3251 idle power loss is always less than 1W - even when hot!
 Highest Output Power to Idle-Loss ratio ever!



Peak Power vs Continuous Power



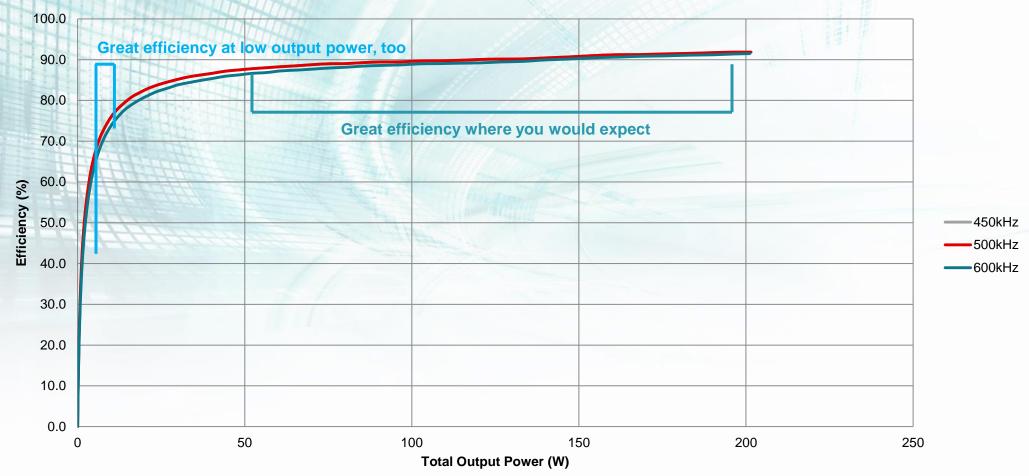


- Low average power or low crestfactor applications may not require a heatsink
- TPA32xx family of devices have a pad-up or pad-down option for most power levels allowing either a heatsink or the PCB to be used for dissipating heat.
- This allows applications to deliver high peak power for short durations, while maintaining a small solution size.

Efficiency

TPA3251 Efficiency vs Output Power

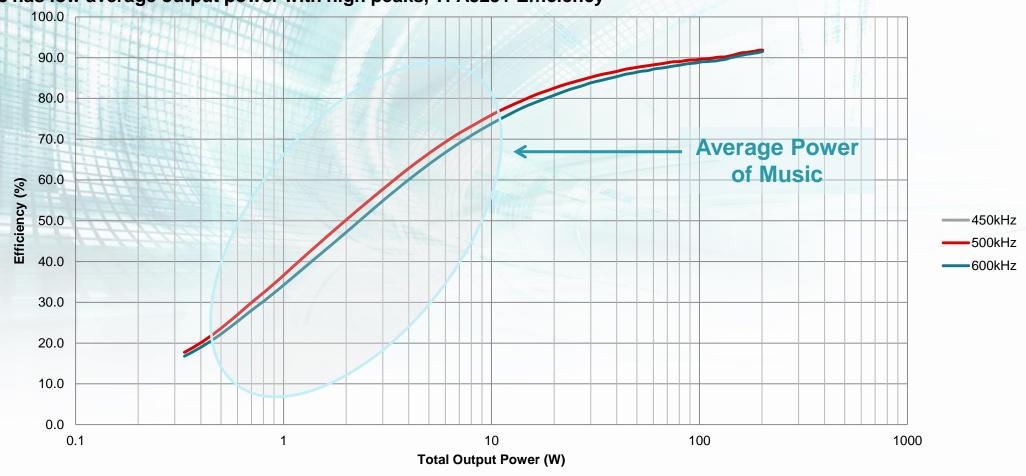




Efficiency at Low Output Power (Zoomed In)



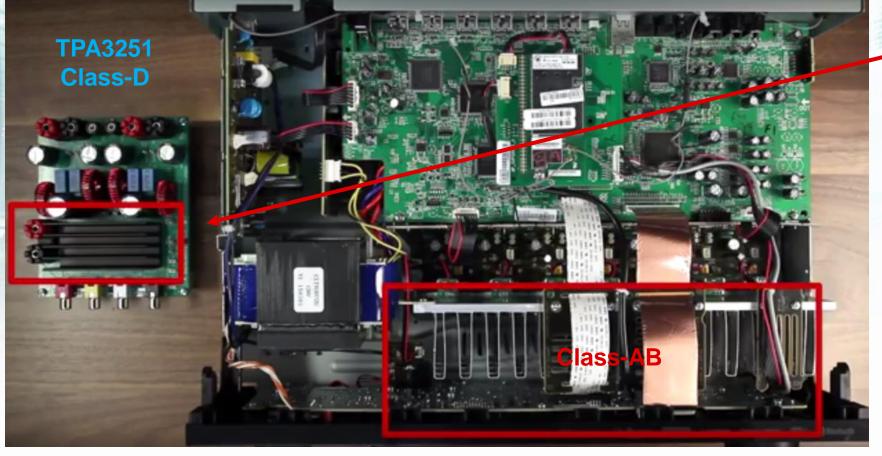
Music has low average output power with high peaks, TPA3251 Efficiency



Solution Size: Class-AB vs Class-D



Reduced heatsink size



Smallest Solution Size Integrated Protection

Save space, component costs and assembly costs

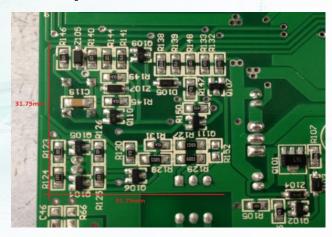
TPA3251 with integrated protection

- Clipping Detection
- Over-current protection
- Cycle-by-Cycle Current Limit
- Over temperature Warning (OTW)
- Over temperature Shutdown (OTE)
- Under voltage
- DC Protection (BTL)
- Pin to Pin short (PPSC)

No additional components required



Compared with a discrete Class-D



Protection Circuitry: 31.75mm x 31.75mm

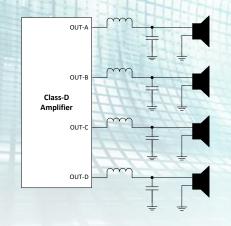
1008 mm² Additional Component Area



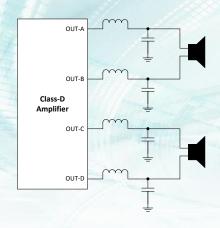
Flexible Output Configuration



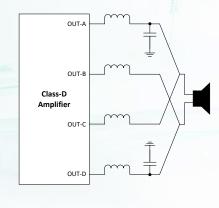
The TPA32xx family supports single-ended (SE), bridge-tied load (BTL), and parallel bridge-tied load (PBTL) output configurations.



4 Channels - Single-Ended



2 Channels - Bridge-Tied Load (BTL)



1 Channel – Parallel Bridge-Tied Load (PBTL)

Supports small speaker impedances down to 2Ω

Power Supply Reference Designs











30V, 200W

PMP10710 - Stereo TI Design

- TI Audio: TAS5611A
 TI Power: LM5122
- Applications
 - Portable PA Speakers
 - Public Announcement Systems
 - Portable Speakers
 - Mini and Micro Audio Systems

36V, 800W

PMP10215 - 400W (800W peak)

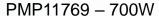
- TI Audio: TPA3251, TPA3250, TPA3244, TPA3255
- TI Power: UCC27714
- Applications
 - PA Systems
 - · AVR, Wireless AVRs
 - High-Power Speaker Bars

50V, 600W

SLOU293C - 600W

- TI Audio: TPA3255
- TI Power: UCC25600
- Applications
 - High-Voltage Audio
 - PA Systems
 - AVR, Wireless AVRs
 - High-Power Speaker Bars

36V, 700W



- **TI Audio:** TPA3251, TPA3250,
- TPA3244, TPA3245
- TI Power: LM25122
- Dual Phase Boost Design
- Applications
 - Automotive Amplifiers
 - External high-power, high performance amplifiers



Works well with TI DACs.



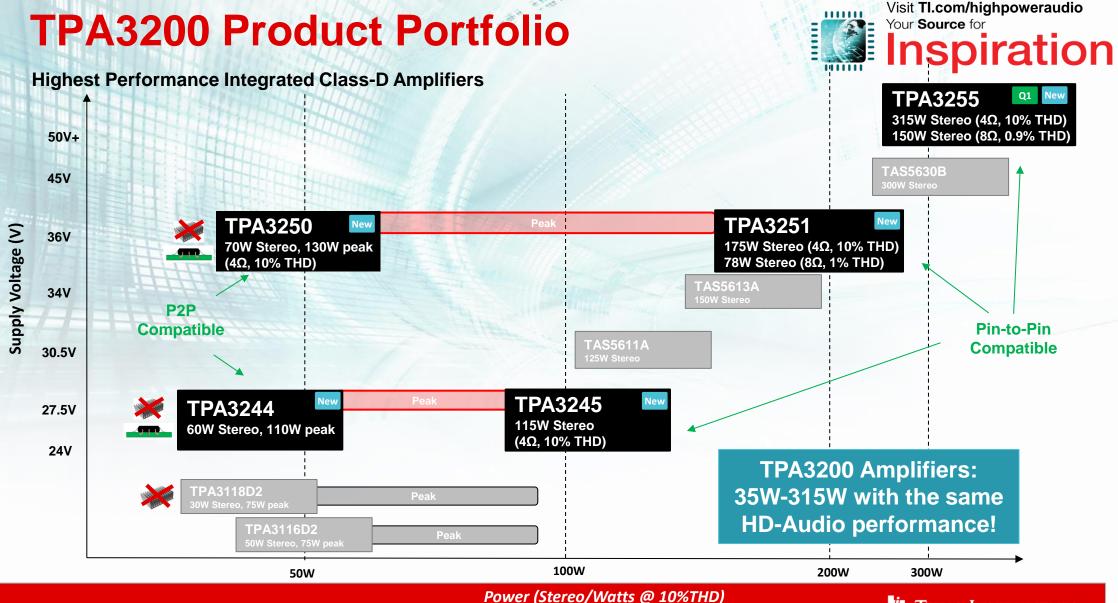
• PCM5242: 2ch 114dB DAC, fully programmable mini-DSP

PCM5252: 2ch 114dB DAC, SmartAmp DSP (New)

PCM1690: 8ch 113dB DAC



Directly connect PCM5242, PCM5252, and PCM1690 directly to the TPA32xx Family, **no filtering or op amps required!**



315W Stereo / 600W Mono PurePath™ Ultra-HD, Analog-In Class-D Amplifier



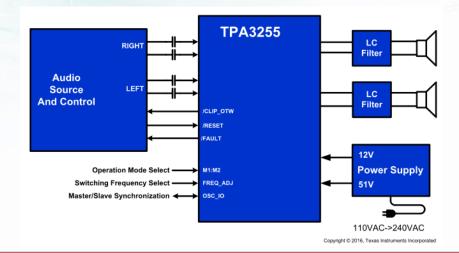
Features

- Total Output Power at 10%THD+N:
 - 315-W Stereo into 4 Ω in BTL Configuration
 - 195-W Stereo into 8 Ω in BTL Configuration
 - 600-W Mono into 2 Ω in PBTL Configuration
- \uparrow 90% Efficient Class-D (4 Ω , stereo) with 80m Ω MOSFETs
- <0.005% THD+N at $1W/4\Omega$; <0.01% THD+N to clipping
- <85µV output noise, A-weighted
- >111dB SNR
- Wide 18V to 53.5V supply voltage operation
- Analog inputs; Click & pop free startup

Applications

- Audio Video Receivers (AVR)
- Mini Combo Systems
- Wireless Speakers
- Home Theater in a Box (HTiB) Systems
- Active Speakers and Subwoofers
- Blu-ray Disk™ / DVD

- Highest Performance HD fidelity audio
- · Only a small heatsink is needed
- Smart Amp power stage takes full benefit of maximum peak power
- Class-G compliant
- Few external components
- Full featured integrated protection system
- Configurable as: 2xBTL (Stereo), 1xBTL+2xSE (2.1), 4xSE or 1xPBTL (Mono)



175W Stereo / 350W Mono PurePath™ Ultra-HD, Analog-In Class-D Amplifier



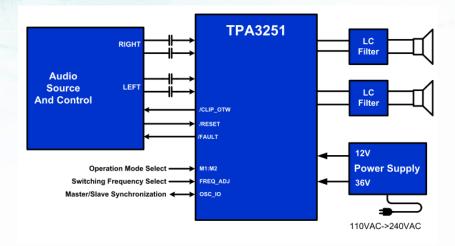
Features

- Total Output Power at 10%THD+N:
 - 175-W Stereo into 4 Ω in BTL Configuration
 - 350-W Mono into 2 Ω in PBTL Configuration
- Up to 90% Efficient Class-D operation (4 Ω) with 60m Ω MF
- <0.005% THD+N at $1W/4\Omega$
- <0.01% THD+N to clipping
- <60µV output noise, A-weighted
- >111dB SNR
- Wide 12V to 36V supply voltage operation
- Analog inputs
- Click & pop free startup

Applications

- Active Speakers and Subwoofers
- Sound bars
- Mini Combo Systems
- Home Theater in a Box (HTiB) Systems
- Wireless Speakers
- Blu-ray Disk™ / DVD

- Highest Performance HD fidelity audio
- Only a small heatsink is needed
- Smart Amp power stage takes full benefit of maximum peak power
- Class-G compliant
- Few external components
- Full featured integrated protection system
- Configurable as: 2xBTL, 1xBTL+2xSE, 4xSE & 1xPBTL



70W Stereo / 130W Peak Ultra-HD, Analog-In, Pad-Down Class-D Amplifier



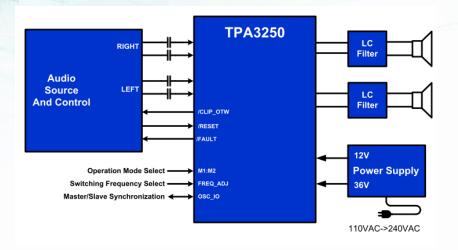
Features

- 70W stereo / 8Ω (BTL) Continuous
- 130W / 4Ω (BTL, 10% THD+N) Peak
- Up to 92% Efficient Class-D (8 Ω , stereo) w/60m Ω MOSFETs
- <0.005% THD+N at $1W/4\Omega$
- <0.01% THD+N to clipping
- <60µV output noise, A-weighted
- >110dB SNR
- Wide 12V to 36V supply voltage operation
- Analog inputs
- Click & pop free startup

Applications

- Audio Video Receivers (AVR)
- Audio Subsystem: Sound Bar
- WIFI Multi-room Speakers
- Audio Subsystem: Home Theater in a Box (HTiB)
- Audio Subsystem: Speaker Dock

- Highest Performance HD fidelity audio
- No need for heatsink (cooling to PCB)
- Smart Amp power stage takes full benefit of maximum peak power
- Class-G compliant
- Few external components
- Full featured integrated protection system
- Configurable as: 2xBTL, 1xBTL+2xSE, 4xSE & 1xPBTL



115W Stereo / 230W Mono PurePath™ Ultra-HD, Analog-In Class-D Amplifier



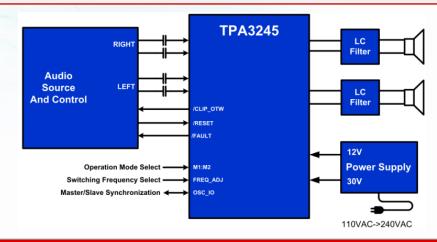
Features

- Total Output Power at 10%THD+N:
 - 115-W Stereo into 4 Ω in BTL Configuration
 - 145-W Stereo into 3 Ω in BTL Configuration
 - 230-W Mono into 2 Ω in PBTL Configuration
- \uparrow 90% Efficient Class-D (4 Ω , stereo) with 60m Ω MOSFETs
- <0.005% THD+N at 1W/4 Ω ; <0.01% THD+N to clipping
- <55µV output noise, A-weighted
- >111dB SNR
- Wide 12V to 30V supply voltage operation
- Analog inputs; Click & pop free startup

Applications

- Home Theater in a Box (HTiB) Systems
- Wireless Speakers
- Sound bars
- Mini Combo Systems
- Active Speakers and Subwoofers
- Blu-ray Disk™ / DVD

- Highest Performance HD fidelity audio
- · Only a small heatsink is needed
- Smart Amp power stage takes full benefit of maximum peak power
- Class-G compliant
- Few external components
- Full featured integrated protection system
- Configurable as: 2xBTL (Stereo), 1xBTL+2xSE (2.1), 4xSE or 1xPBTL (Mono)



60W Stereo / 110W Peak Ultra-HD Analog-In, Pad-Down Class-D Amplifier



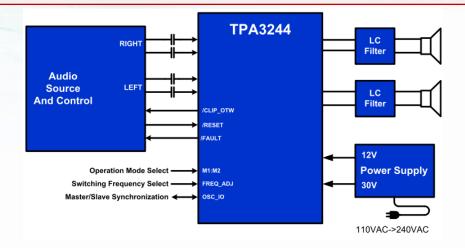
Features

- 60W stereo / 8Ω (BTL) Continuous
- 110W / 4Ω (BTL, 10% THD+N) Peak
- Up to 92% Efficient Class-D operation
- <0.005% THD+N at $1W/4\Omega$
- <0.01% THD+N to clipping
- <55µV output noise, A-weighted
- >110dB SNR
- Wide 12V to 32V supply voltage operation
- Analog inputs
- Click & pop free startup

Applications

- Wireless Speakers
- Sound bars
- Mini Combo Systems
- Active Speakers and Subwoofers
- HTiB Systems
- Blu-ray Disk™ / DVD Receivers

- Highest Performance HD fidelity audio
- No need for a heatsink (cooling to PCB)
- Smart Amp power stage takes full benefit of maximum peak power
- Class-G compliant
- Few external components
- Full featured integrated protection system
- Configurable as: 2xBTL, 1xBTL+2xSE, 4xSE & 1xPBTL



Experience the TPA32xx

Experience the most realistic sound on the market

Device	Max Power to BTL/Ch (W) Stereo	Max Power to PBTL (W) Mono
TPA3255	315	605
TPA3251	220	355
TPA3250	130	190
TPA3245	145	230
TPA3244	110	160

- Best Noise & THD Performance
 < 0.001% THD, < 60uV noise
- EVM Includes:
 - TPA32xx Device
 - Output Filter & passive components optimized for superb performance
- Ask about a demo at your location or visit
 Tl.com/highpoweraudio



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